SCLS486A - MAY 2003 - REVISED JUNE 2003

20 🛛 V<sub>CC</sub>

19 20E

18 1Y1

17 1 2A4

16 **1** 1Y2

15 2A3

14 1Y3

13 2A2

12 1Y4

11 2A1

DW OR PW PACKAGE

(TOP VIEW)

10E

1A1 🛛 2

2Y4 🛛 3

1A2 4

2Y3 🛛 5

1A3 🛛 6

2Y2 🛛 7

1A4 **1**8

2Y1 🛛 9

GND 10

- **Controlled Baseline** - One Assembly/Test Site, One Fabrication Site
- **Extended Temperature Performance of** -55°C to 125°C
- **Enhanced Diminishing Manufacturing** Sources (DMS) Support
- **Enhanced Product-Change Notification** •
- **Qualification Pedigree<sup>†</sup>**
- **EPIC™** (Enhanced-Performance Implanted • CMOS) Process
- Operating Range 2-V to 5.5-V V<sub>CC</sub>
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- **ESD Protection Exceeds 1500 V Per** MIL-STD-833, Method 3015; Exceeds 150 V Using Machine Model (C = 200 pF, R = 0)

<sup>†</sup> Component qualification in accordance with JEDEC and industry standards to ensure reliable operation over an extended temperature range. This includes, but is not limited to, Highly Accelerated Stress Test (HAST) or biased 85/85, temperature cycle, autoclave or unbiased HAST, electromigration, bond intermetallic life, and mold compound life. Such qualification testing should not be viewed as justifying use of this component beyond specified performance and environmental limits.

#### description/ordering information

This octal buffer/driver is designed specifically to improve the performance and density of 3-state memory-address drivers, clock drivers, and bus-oriented receivers and transmitters.

The SN74AHC244 is organized as two 4-bit buffers/line drivers with separate output-enable ( $\overline{OE}$ ) inputs. When  $\overline{OE}$  is low, the device passes data from the A inputs to the Y outputs. When  $\overline{OE}$  is high, the outputs are in the high-impedance state.

To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to V<sub>CC</sub> through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

TA	PAC	(AGE <sup>‡</sup>	ORDERABLE PART NUMBER	TOP-SIDE MARKING	
–55°C to 125°C	SOIC – D	Tape and reel	SN74AHC244MDWREP	AHC244MEP	
	TSSOP – PW	Tape and reel	SN74AHC244MPWREP	AHC244EP	

#### ORDERING INFORMATION

<sup>‡</sup> Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



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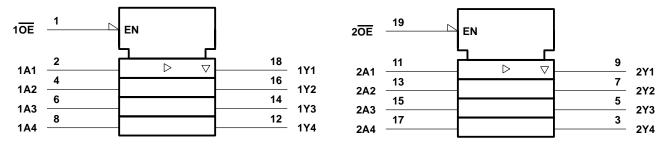
PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



# FUNCTION TABLE

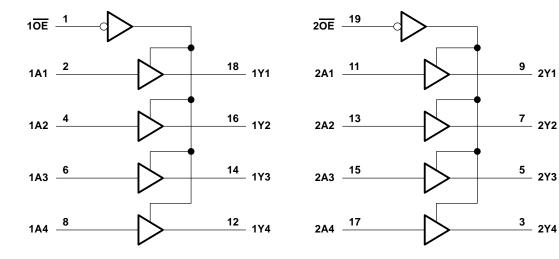
(each	4-bit bu	ffer/driver)
INP	UTS	OUTPUT
OE	Α	Y
L	Н	Н
L	L	L
н	х	Z

## logic symbol<sup>†</sup>



<sup>†</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

#### logic diagram (positive logic)





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#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V <sub>CC</sub>	–0.5 V to 7 V
Input voltage range, V <sub>I</sub> (see Note 1)	–0.5 V to 7 V
Output voltage range, V <sub>O</sub> (see Note 1)	-0.5 V to V <sub>CC</sub> + 0.5 V
Input clamp current, I <sub>IK</sub> (V <sub>I</sub> < 0)	–20 mA
Output clamp current, $I_{OK}$ ( $V_O < 0$ or $V_O > V_{CC}$ )	±20 mA
Continuous output current, $I_O (V_O = 0 \text{ to } V_{CC})$	
Continuous current through V <sub>CC</sub> or GND	
Package thermal impedance, $\theta_{JA}$ (see Note 2): DW package	58°C/W
PW package	
Storage temperature range, T <sub>stg</sub>	
resses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These	e are stress ratings only and

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. The package thermal impedance is calculated in accordance with JESD 51-7.

#### recommended operating conditions (see Note 3)

			MIN	MAX	UNIT
VCC	Supply voltage		2	5.5	V
		$V_{CC} = 2 V$	1.5		
VIH	High-level input voltage	$V_{CC} = 3 V$	2.1		V
		V <sub>CC</sub> = 5.5 V	3.85		
		$V_{CC} = 2 V$		0.5	
VIL	Low-level input voltage V <sub>CC</sub> = 3 V	$V_{CC} = 3 V$		0.9	V
		$V_{CC} = 5.5 V$		1.65	
VI	Input voltage		0	5.5	V
VO	Output voltage		0	VCC	V
		$V_{CC} = 2 V$		-50	μA
ЮН	High-level output current	$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$		-4	~ ^
		$V_{CC}$ = 5 V ± 0.5 V		-8	mA
		V <sub>CC</sub> = 2 V		50	μA
IOL	Low-level output current	$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$		4	~ ^
		$V_{CC}$ = 5 V ± 0.5 V		8	mA
A+/A1-	Input transition rise or fall rate	$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$		100	<b>n</b> 0//
$\Delta t / \Delta v$	Input transition rise or fall rate	$V_{CC} = 5 V \pm 0.5 V$		20	ns/V
TA	Operating free-air temperature		-55	125	°C

NOTE 3: All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



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# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DADAMETED	TEST CONDITIONS	Vaa	T,	<b>₄ = 25°C</b>	;	MIN	MAY	UNIT
PARAMETER	TEST CONDITIONS	Vcc	MIN	TYP	MAX	MIN	MAX	UNIT
		2 V	1.9	2		1.9		
	I <sub>OH</sub> = -50 μA	3 V	2.9	3		2.9		
VOH		4.5 V	4.4	4.5		4.4		V
	$I_{OH} = -4 \text{ mA}$	3 V	2.58			2.48		
	I <sub>OH</sub> = -8 mA	4.5 V	3.94			3.8		
		2 V			0.1		0.1	
	I <sub>OL</sub> = 50 μA	3 V			0.1		0.1	
VOL		4.5 V			0.1		0.1	V
	I <sub>OL</sub> = 4 mA	3 V			0.36		0.5	
	I <sub>OL</sub> = 8 mA	4.5 V			0.36		0.5	
lj	V <sub>I</sub> = 5.5 V or GND	0 V to 5.5 V			±0.1		±1	μA
I <sub>OZ</sub>	$V_{O} = V_{CC} \text{ or GND},  V_{I} (\overline{OE}) = V_{IL} \text{ or } V_{IH}$	5.5 V			±0.25		±2.5	μA
Icc	$V_{I} = V_{CC} \text{ or } GND, \qquad I_{O} = 0$	5.5 V			4		40	μΑ
Ci	$V_I = V_{CC}$ or GND	5 V		2	10			рF
Co	$V_{O} = V_{CC}$ or GND	5 V		3.5				pF

# switching characteristics over recommended operating free-air temperature range, $V_{CC}$ = 3.3 V $\pm$ 0.3 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	то	LOAD	ТА	. = 25°C	;	MIN	МАХ	UNIT	
PARAMETER	(INPUT)	Γ) (OUTPUT)	(INPUT) (OUTPUT) CAP	CAPACITANCE	MIN	TYP	MAX	IVIIIN	MAX	UNIT
<sup>t</sup> PLH	A	Y	C <sub>L</sub> = 15 pF		5.8	8.4	1	10	ns	
<sup>t</sup> PHL	A	T			5.8	8.4	1	10	115	
<sup>t</sup> PZH		Y	C <sub>1</sub> = 15 pF		6.6	10.6	1	12.5	ns	
<sup>t</sup> PZL	UE	Ι	C[ = 15 pr		6.6	10.6	1	12.5	115	
<sup>t</sup> PHZ		Y	C <sub>L</sub> = 15 pF		5	9.7	1	11	ns	
<sup>t</sup> PLZ	UE	Ι	CL = 15 pr		5	9.7	1	11	113	
<sup>t</sup> PLH	A	Y	C <sub>L</sub> = 50 pF		8.3	11.9	1	13.5	ns	
<sup>t</sup> PHL		T	CL = 50 pr		8.3	11.9	1	13.5	115	
<sup>t</sup> PZH		Y	C <sub>L</sub> = 50 pF		9.1	14.1	1	16	ns	
<sup>t</sup> PZL		T	CL = 50 pF		9.1	14.1	1	16	IIS	
<sup>t</sup> PHZ	OE	Y	$C_{1} = 50 \text{ pF}$		10.3	14	1	16	ns	
<sup>t</sup> PLZ		Ť	C <sub>L</sub> = 50 pF		10.3	14	1	16	115	



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# switching characteristics over recommended operating free-air temperature range, $V_{CC}$ = 5 V $\pm$ 0.5 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	то	LOAD	Τ <sub>4</sub>	∖ = 25°C	;	MIN	МАХ	UNIT		
PARAMETER	(INPUT)	(OUTPUT)	CAPACITANCE	MIN	TYP	MAX	IVIIIN	WAA	UNIT		
<sup>t</sup> PLH	А	Y	C <sub>I</sub> = 15 pF		3.9	5.5	1	6.5	ns		
<sup>t</sup> PHL	~	ř	CL = 13 pr		3.9	5.5	1	6.5	115		
<sup>t</sup> PZH	OE	Y	Ci – 15 pF		4.7	7.3	1	8.5	20		
<sup>t</sup> PZL	OE	Ť	ſ	T	C <sub>L</sub> = 15 pF		4.7	7.3	1	8.5	ns
<sup>t</sup> PHZ	OE	Y	C <sub>L</sub> = 15 pF		5	7.2	1	8.5	ns		
<sup>t</sup> PLZ	ÛE	Ť	CL = 13 pr		5	7.2	1	8.5	113		
<sup>t</sup> PLH	А	Y	$C_{\rm L} = 50  \rm pE$		5.4	7.5	1	8.5	ns		
<sup>t</sup> PHL	~	Ι	Y $C_{L} = 50 \text{ pF}$		5.4	7.5	1	8.5	115		
<sup>t</sup> PZH	OE	Y	$C_{\rm L} = 50  \rm pE$		6.2	9.3	1	10.5	ns		
<sup>t</sup> PZL	UE	ſ	C <sub>L</sub> = 50 pF		6.2	9.3	1	10.5	115		
<sup>t</sup> PHZ	OE	Y	$C_{\rm L} = 50  \rm pF$		6.7	9.2	1	10.5	20		
<sup>t</sup> PLZ	UE	r	C <sub>L</sub> = 50 pF		6.7	9.2	1	10.5	ns		

# noise characteristics, V<sub>CC</sub> = 5 V, C<sub>L</sub> = 50 pF, T<sub>A</sub> = 25°C (see Note 4)

	PARAMETER	MIN	TYP	MAX	UNIT
VOL(P)	Quiet output, maximum dynamic V <sub>OL</sub>		0.5		V
VOL(V)	Quiet output, minimum dynamic V <sub>OL</sub>		-0.2		V
VOH(V)	Quiet output, minimum dynamic V <sub>OH</sub>		4.8		V
VIH(D)	High-level dynamic input voltage	3.5			V
V <sub>IL(D)</sub>	Low-level dynamic input voltage			1.5	V

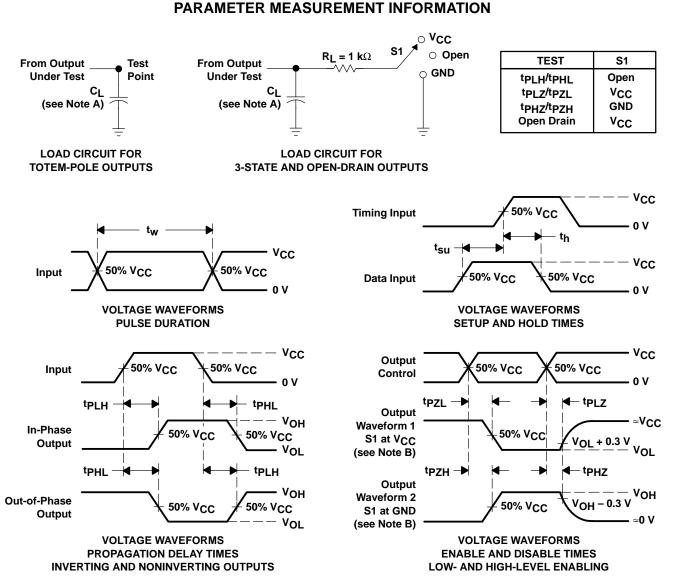
NOTE 4: Characteristics are for surface-mount packages only.

## operating characteristics, V<sub>CC</sub> = 5 V, T<sub>A</sub> = $25^{\circ}$ C

	PARAMETER	TEST CO	ONDITIONS	TYP	UNIT
C <sub>pd</sub>	Power dissipation capacitance	No load,	f = 1 MHz	8.6	pF



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NOTES: A. CL includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  1 MHz, Z<sub>O</sub> = 50  $\Omega$ , t<sub>f</sub>  $\leq$  3 ns, t<sub>f</sub>  $\leq$  3 ns.

D. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms





### **PACKAGING INFORMATION**

Orderable Device	Status	Package Type	•	Pins	•	Eco Plan	Lead finish/	MSL Peak Temp	Op Temp (°C)	Device Marking	Samples
	(1)		Drawing		Qty	(2)	Ball material	(3)		(4/5)	
SN74AHC244MDWREP	ACTIVE	SOIC	DW	20	2000	RoHS & Green	(6) NIPDAU	Level-1-260C-UNLIM	-55 to 125	AHC244MEP	
SIN/4AIIC244IVIDWREF	ACTIVE	3010	DVV	20	2000	Kulis & Gleen	NIFDAU		-55 10 125	AIICZ44MEF	Samples
SN74AHC244MPWREP	ACTIVE	TSSOP	PW	20	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-55 to 125	AHC244EP	Samples
SN74AHC244MPWREPG4	ACTIVE	TSSOP	PW	20	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-55 to 125	AHC244EP	Samples
V62/03649-01XE	ACTIVE	TSSOP	PW	20	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-55 to 125	AHC244EP	Samples
V62/03649-01YE	ACTIVE	SOIC	DW	20	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-55 to 125	AHC244MEP	Samples

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <= 1000ppm threshold. Antimony trioxide based flame retardants must also meet the <= 1000ppm threshold requirement.

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

<sup>(5)</sup> Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

<sup>(6)</sup> Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.



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#### OTHER QUALIFIED VERSIONS OF SN74AHC244-EP :

- Catalog: SN74AHC244
- Automotive: SN74AHC244-Q1
- Military: SN54AHC244

NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Automotive Q100 devices qualified for high-reliability automotive applications targeting zero defects
- Military QML certified for Military and Defense Applications



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STRUMENTS

### TAPE AND REEL INFORMATION





#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal												
Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74AHC244MDWREP	SOIC	DW	20	2000	330.0	24.4	10.8	13.3	2.7	12.0	24.0	Q1
SN74AHC244MPWREP	TSSOP	PW	20	2000	330.0	16.4	6.95	7.0	1.4	8.0	16.0	Q1



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# PACKAGE MATERIALS INFORMATION

3-Jun-2022



\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74AHC244MDWREP	SOIC	DW	20	2000	367.0	367.0	45.0
SN74AHC244MPWREP	TSSOP	PW	20	2000	356.0	356.0	35.0

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